

**Listing of Claims:**

The listing of claims will replace all prior versions, and listings, of claims in the application.

1. (Previously Amended) A nitride-based HEMT capable of high-frequency operation comprising:

a substrate;

a channel layer comprising InAlGaN on the substrate;

a barrier layer comprising InAlGaN on the channel layer, the barrier layer having a bandgap greater than a bandgap of the channel layer, the barrier layer and the channel layer cooperatively inducing a two-dimensional electron gas at an interface between the channel layer and the barrier layer;

at least one energy barrier adjacent one of the barrier layer and/or the channel layer, the energy barrier comprising a fully depleted, delta doped electron source layer in proximity with and spaced apart from a fully depleted, delta doped hole source layer by a high field region.

2. (Original) A HEMT according to claim 1, wherein the electron source layer comprises a layer doped with n-type dopants.

3-4. (Cancelled)

5. (Original) A HEMT according to claim 1, wherein the hole source layer comprises a layer doped with p-type dopants.

6. (Original) A HEMT according to claim 1, wherein the hole source layer comprises a layer co-doped with deep-level transition elements and shallow acceptor dopants.

7. (Original) A HEMT according to claim 1, wherein the hole source layer comprises a layer doped with deep-level acceptor dopants .

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8-10. (Cancelled)

11. (Original) A HEMT according to claim 1, wherein the energy barrier provides a built-in potential barrier in excess of about 0.5V.

12. (Original) A HEMT according to claim 1, wherein the energy barrier provides a built-in potential barrier in excess of about 1V.

13. (Original) A HEMT according to claim 1, wherein the energy barrier provides a built-in potential barrier in excess of about 2V.

14. (Original) A HEMT according to claim 1, wherein the energy barrier has an associated electric field directed away from the channel.

15. (Original) A HEMT according to claim 1, wherein the energy barrier arises due to charge transfer between the electron source layer and the hole source layer.

16. (Original) A HEMT according to claim 1, wherein the energy barrier has a peak electric field in excess of about  $10^5$  V/cm.

17. (Previously Amended) A nitride-based HEMT capable of high-frequency operation comprising:

a substrate;

a channel layer comprising  $\text{Al}_x\text{Ga}_{1-x}\text{N}$  ( $0 \leq x \leq 1$ ) on the substrate;

a barrier layer comprising  $\text{Al}_y\text{Ga}_{1-y}\text{N}$  ( $0 < y \leq 1$ ) on the channel layer, the barrier layer having a bandgap greater than a bandgap of the channel layer, the barrier layer and the channel layer cooperatively inducing a two-dimensional electron gas at an interface between the channel layer and the barrier layer; and

at least one energy barrier in the barrier layer, the energy barrier comprising a fully depleted, delta doped electron source layer in proximity with and spaced apart from a fully depleted, delta doped hole source layer by a high field region and opposing the movement of electrons away from the channel layer.

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18. (Previously Amended) A nitride-based HEMT capable of high-frequency operation comprising:

a substrate;

a channel layer comprising  $\text{Al}_x\text{Ga}_{1-x}\text{N}$  ( $0 \leq x \leq 1$ ) on the substrate;

a barrier layer comprising  $\text{Al}_y\text{Ga}_{1-y}\text{N}$  ( $0 < y \leq 1$ ) on the channel layer, the barrier layer having a bandgap greater than a bandgap of the channel layer, the barrier layer and the channel layer cooperatively inducing a two-dimensional electron gas at an interface between the channel layer and the barrier layer;

at least one energy barrier between the two-dimensional electron gas and the substrate, the energy barrier comprising a fully depleted, delta doped electron source layer in proximity with and spaced apart from a fully depleted, delta doped hole source layer by a high field region and opposing the movement of electrons away from the interface between the barrier layer and the channel layer.

19. (Previously Amended) A field effect transistor comprising:

a substrate;

a channel layer comprising InAlGaN on the substrate;

source and drain ohmic contacts in electrical communication with the channel layer;

a gate contact on the channel layer;

at least one energy barrier between the channel layer and the substrate, the energy barrier comprising a fully depleted, delta doped electron source layer in proximity with and spaced apart from a fully depleted, delta doped hole source layer by a high field region.

20. (Previously Amended) A field effect transistor comprising:

a substrate;

a buffer layer on the substrate

a channel layer comprising InAlGaN on the buffer layer;

source and drain ohmic contacts in electrical communication with the channel layer;

a gate contact on the channel layer;

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a fully depleted, delta doped electron source layer between the channel and the buffer;

a fully depleted, delta doped hole source layer between the electron source layer and the buffer;

a high field region between the electron source layer and the hole source layer, the high field region providing an energy barrier opposed to the movement of electrons away from the channel layer toward the buffer.

21-36. (Cancelled)

37. (Currently Amended) [[The nitride-based HEMT of Claim 31]] A nitride-based HEMT capable of high-frequency operation comprising:

a Group III-nitride based channel layer on a substrate;

a Group III-nitride based barrier layer on the channel layer, the barrier layer having a bandgap greater than a bandgap of the channel layer, the barrier layer and the channel layer cooperatively inducing a two-dimensional electron gas at an interface between the channel layer and the barrier layer; and

a quantum well adjacent the channel layer and configured to generate a built-in potential that opposes movement of carriers away from the channel layer, wherein the quantum well comprises:

a first nitride layer adjacent the channel layer, the first nitride layer having a band gap that is narrower than a band gap of the channel layer and a lattice constant that is larger than a lattice constant of the channel layer; and

a second Group III-nitride based layer adjacent the first nitride layer and opposite the channel layer, the second Group III-nitride based layer having a band gap and a lattice constant that are substantially the same as the band gap and lattice constant of the channel layer.

38. (Original) The nitride-based HEMT of Claim 37, wherein the first nitride layer comprises InN and the channel layer and second Group III-nitride based layer comprise GaN.

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39. (Original) The nitride-based HEMT of Claim 37, wherein the first nitride layer has a thickness of about one or two monolayers.

40. (Original) The nitride-based HEMT of Claim 37, wherein the channel layer has a thickness of from about 30 Å to about 300 Å.